SN5433, SN54LS33, SN7433, SN74LS33 QUADRUPLE 2-INPUT POSITIVE NOR BUFFERS WITH OPEN-COLLECTOR OUTPUTS

SDLS101

DECEMBER 1983-REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic **DIPs**
- Dependable Texas Instruments Quality and Reliability

description

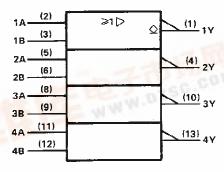
These devices contain four independent 2-input NOR buffer gates with open-collector outputs. Opencollector outputs require resistive pull-up to perform logically but can deliver higher VOH levels and are commonly used in wired-AND applications.

The SN5433 and SN54LS33 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN7433, and SN74LS33 are characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each gate)

INP	UTS	OUTPUT
A	В	Y) 7.5
Н	Х	L
X	н	Ŀ
L	L	н

logic symbol†



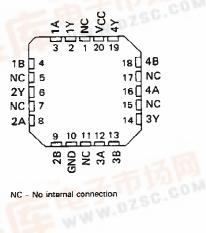
[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN5433, SN54LS33 . . . J OR W PACKAGE SN7433 . . . N PACKAGE SN74LS33 . . . D OR N PACKAGE (TOP VIEW)

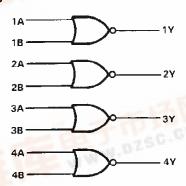
1YC	1	U14 Vcc
1AC	2	13 4Y
1B C	3	12 4B
2Y 🗀	4	11 4A
2A 🗆	5	10 □ 3Y
2B 🗀	6	9 🗖 3₿
GND [7	8] 3A

SN54LS33 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

logic diagram

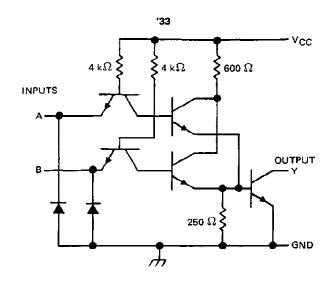


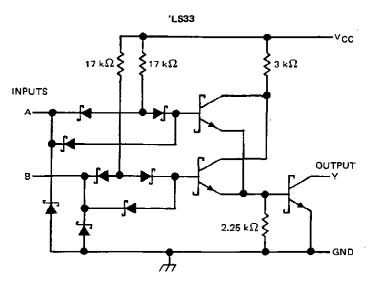
positive logic

$$Y = \overline{A + B} \text{ or } Y = \overline{A \cdot B}$$

SN5433, SN54LS33, SN7433, SN74LS33 QUADRUPLE 2-INPUT POSITIVE-NOR BUFFERS WITH OPEN-COLLECTOR OUTPUTS

schematics (each gate)





Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)
Input voltage: '33 5.5 V
'L\$33 7 V
Off-state output voltage
Operating free-air temperature: SN54'
SN74′
Storage temperature range
ITE 1: Voltage values are with respect to network ground terminal.

SN5433, SN7433 QUADRUPLE 2-INPUT POSITIVE-NOR BUFFERS WITH OPEN-COLLECTOR OUTPUTS

recommended operating conditions

			SN5433			SN7433			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
ViH	High-level input voltage	2			2			V	
۷ _{IL}	Low-level input voltage			0.8			0.8	٧	
Vон	High-level output voltage			5.5			5.5		
loL	Low-level output current			48			48	mA	
TA	Operating free-air temperature	- 55		125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†	SN5433					
	TEST CONDITIONS.	MIN TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	V _{CC} = MIN, I _I = -12 mA		- 1.5			- 1.5	V
1	$V_{CC} = MIN, V_{IL} = 0.8 \text{ V}, V_{OH} = 5.5 \text{ V}$					0.25	
юн	$V_{CC} = MIN, V_{IL} = 0.7 \text{ V}, V_{OH} = 5.5 \text{ V}$		0.25				mA
VOL	V _{CC} = MIN. V _{IH} ≈ 2 V, I _{OL} = 16 mA	0.2	0.4		0.2	0.4	V
lı lı	V _{CC} = MAX, V _I = 5.5 V		1			1	mΑ
ļіН	V _{CC} = MAX, V ₁ = 2.4 V		40			40	μА
կլ	$V_{CC} = MAX, V_1 = 0.4 V$		- 1.6			- 1.6	mA
Іссн	VCC = MAX, VI = 0	3	6		3	6	mA
ICCL	V _{CC} = MAX, See Note 2	9	16.5		9	16.5	mA

^{*}For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, VCC = 5 V, TA = 25 °C (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
tPLH		A or B Y	$R_{I} = 133 \text{ k}\Omega, C_{I} = 50 \text{ pF}$	<u> </u>	10	15	ns
[†] PHL	A or B		n[= 133 kt/, C[= 50 pr		12	18	ns
tPLH			D 12210 C 1505		15	22	⊓\$
tPHL			$R_L = 133 \text{ k}\Omega$, $C_L = 150 \text{ pF}$		16	24	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

 $^{^{\}ddagger}$ All typical values are at V_{CC} = 5 V, T_A = 25 °C. NOTE 2: One input at 4.5 V, all others at 0 V.

SN54LS33, SN74LS33 QUADRUPLE 2 INPUT POSITIVE NOR BUFFERS WITH OPEN-COLLECTOR OUTPUTS

recommended operating conditions

	S	SN54L\$33			SN74LS33			
	MIN	MOM	MAX	MIN	NOM	MAX	UNIT	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
V _{IH} High-level input voltage	2			2			V	
VIL Low-level input voltage			0.7			8.0	V	
VOH High-level output voltage			5.5			5.5	V	
IOL Low-level output current			12			24	mΑ	
TA Operating free-air temperature	- 55	-	125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †				SN54LS33			SN74LS33		
PARAMETER				MIN	TYP ‡	MAX	MIN	TYP ‡	MAX	UNIT
VIK	V _{CC} = MIN,	I _I = - 18 mA				- 1.5	i —	-	- 1.5	V
¹ ОН	VCC = MIN,	V _{IH} = 2 V,	VIL = MAX, VOH = 5.5 V	1		0.25			0.25	mΑ
\r.	$V_{CC} = MIN.$	$V_{IH} = 2 V$	VIL = MAX, IOL = 12 mA		0.25	0.4		0.25	0.4	0.4 0.5
VOL	V _{CC} = MIN,	VIL = MAX,	I _{OL} = 24 mA				<u> </u>	0.35	0.5	
ΙĮ	VCC = MAX,	V ₁ = 7 V				0.1			0.1	mΑ
¹iH	V _{CC} = MAX,	V ₁ = 2.7 V				20			20	μА
lir.	V _{CC} = MAX,	V ₁ = 0.4 V				- 0,4			- 0.4	mA
Іссн	VCC = MAX.	V _I = 0		1	1.8	3.6		1.8	3.6	mA
ICCL	VCC = MAX.	See Note 2			6.9	13.8		6.9	13.8	mA

 $^{^{\}dagger}$ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at V_{CC} = 5 V, T_A = 25 °C. NOTE 2: One input at 4.5 V, all others at 0 V.

switching characteristics, VCC = 5 V, TA = 25°C (see note 3)

	PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
	^t PLH	A or B	Y	$R_1 \sim 667 \Omega$, $C_1 = 45 pF$	<u> </u>	20	32	ns
Г	¹₽HL	1, 3, 5	_ `			18	28	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

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